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Mark Ader

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application for:

Steven Teig, et al.

Serial No.: 10/046,858

Filing Date: 1/13/02

For: **METHOD AND APPARATUS FOR
PLACING CIRCUIT MODULES**

PRELIMINARY AMENDMENT

Assistant Commissioner of
Patents and Trademarks
Washington, D.C. 20231

Sir:

Please amend the application as follows:

IN THE SPECIFICATION

Please delete the "Claim of Benefit to Prior Applications" on page 1, lines 2-7,
and insert therein a new "Claim of Benefit to Prior Applications" as follows:

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